

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

## Title of Invention

Homogeneous Copper Interconnects for BEOL

Application Number :

Confirmation Number:

First Named Applicant: Kevin Petrarca

Attorney Docket Number: FIS920040258US1

Art Unit:

Examiner:

Search string: ( 6709562 or 6380628 or 6339258 or 6337151 or 6743719 or 6472023 or 6680514 or 6071814 or 6136707 or 6174799 or 6368961 or 6726535 or 20040021226 or 20020027082 ).pn

## US Patent Documents

**Note: Applicant is not required to submit a paper copy of cited US Patent Documents**

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
THN	1	6709562	2004-03-23	ANDRICACOS, ET AL.			
THN	2	6380628	2002-04-30	MILLER, ET AL.			
THN	3	6339258	2002-01-15	COONEY, III, ET AL.			
THN	4	6337151	2002-01-08	UZOH, ET AL.			
THN	5	6743719	2004-06-01	CHEN, ET AL.			
THN	6	6472023	2002-10-29	WU, ET AL.			
THN	7	6680514	2004-01-20	GEFFKEN, ET AL.			
THN	8	6071814	2000-06-06	JANG			
THN	9	6136707	2000-10-24	COHEN			
THN	10	6174799	2001-01-16	LOPATIN, ET AL.			
THN	11	6368961	2002-04-09	LOPATIN, ET AL.			
THN	12	6726535	2004-04-27	SHIH, ET AL.			

## US Published Applications

**Note: Applicant is not required to submit a paper copy of cited US Published Applications**

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
THN	1	20040021226	2004-02-05	GEFFKEN, ET AL.	/	/	/
THN	2	20020027082	2002-03-07	ANDRICACOS, ET AL	/	/	/

**Signature**

Examiner Name	Date
<i>William G. Meyer</i>	<i>12/29/05</i>